

Academic Paper Acceptance Letter

Dear Bahaa Hussien and Farooq montaz,

It's my pleasure to inform you that, after the peer review, your paper,

Study of D.C Electrical properties of (PMMA- /Ag) nano composites particle

has been ACCEPTED with content unaltered to publish with **Journal of Information Engineering and Applications**. In order to fit into the publishing and printing schedule, please re-submit your complete publication package by directly replying this acceptance email within 8 days so we can make your article available online/print in the next issue (by the end of this month) . If you failed to prepare your complete files on time, the publication of your article might be delayed.

Though the reviewers of the journal already confirmed the quality of your paper's current version, you can still add content to it, such as solidifying the literature review, adding more content in the conclusion, giving more information on your analytical process and giving acknowledgement.

To help the editor of the journal process your final paper quickly, you need to prepare your paper based on the attached "publication_package_instruction.pdf".

Again, thank you for working with IISTE. I believe that our collaboration will help to accelerate the global knowledge creation and sharing one step further.

IISTE looks forward to your final publication package. Please let me know if you have any questions.

Alexander Decker,

Thursday, June 20, 2013

Editor-in-Chief

IISTE-Accelerating Global Knowledge Sharing

The International Institute for Science, Technology and Education

The indexation of the journal

